



Pressure sensors

Pressure transmitters without casing (current output)

Series/Type: CAU-T series
Ordering code:
Date: 2009-08-03
Version: 3

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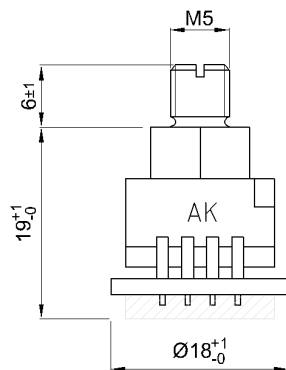
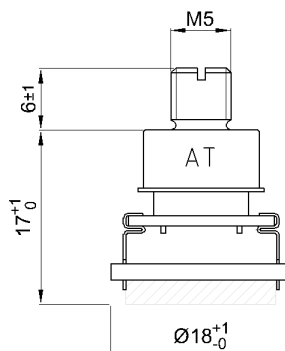
EPCOS AG is a TDK Group Company.

Description

- The transmitters are based on piezoresistive silicon pressure sensors from our own clean room.
- The T-series electronic compensates nonlinearity and temperature errors and supplies a precise calibrated output signal with a high immunity against electromagnetic influences (EMI).

Features

- Piezoresistive MEMS technology
- Measured media (absolute pressure):
Air, non-aggressive gases (gas humidity 0 ... 85% r.h., without dew)
Unsuitable for substances which react with glass, silicon, gold, aluminum, stainless steel, silicone glue or silicone gel.
- Measured media (gauge pressure):
Air, non-aggressive gases (gas humidity 0 ... 100% r.h.)
and non-aggressive fluids.
Unsuitable for substances which react with glass, silicon, stainless steel, silicone glue ($p_r \leq 10$ bar) or epoxy glue ($p_r > 10$ bar).
- 2-wire current output proportional to pressure: 4 ... 20 mA
- Reverse supply voltage protection
- RoHS-compatible, halogen-free
- Without casing (protection IP00)


Dimensional drawings
**Type KC for gauge pressure
(M5 thread connection)**

**Type TH for absolute pressure
(M5 thread connection)**


All dimensions in mm

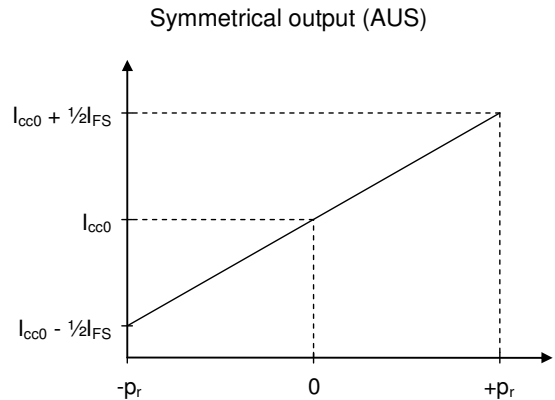
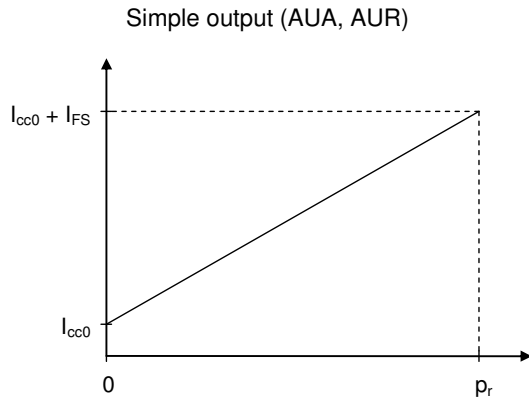
Pressure sensors
Pressure transmitters without casing (current output)
CAU-T series
Technical data
Absolute maximum ratings

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Temperature ranges						
Storage temperature range	T_{st}	1)	-40		+105	°C
Operating temperature range	T_a	2)	-25		+85	°C
Compensated temperature range	T_c	3)	0		+70	°C
Soldering temperature	T_{solder}	<5 s (no reflow soldering)			+240	°C
Pressure ranges						
Overpressure	p_{ov}	4), 5)	1.5			p_r
Supply voltage /-current						
Supply voltage	V_{CC}	See connection diagram ⁶⁾	10		30	V
Current limit ($p \gg p_r$)	I_{CCMAX}		23			mA
Output signal at sensor failure	I_{ERR}				3	mA
Working resistance	R_L	See connection diagram ⁷⁾			1000	Ohm
DC break down voltage	V_{is}	⁸⁾	500			V

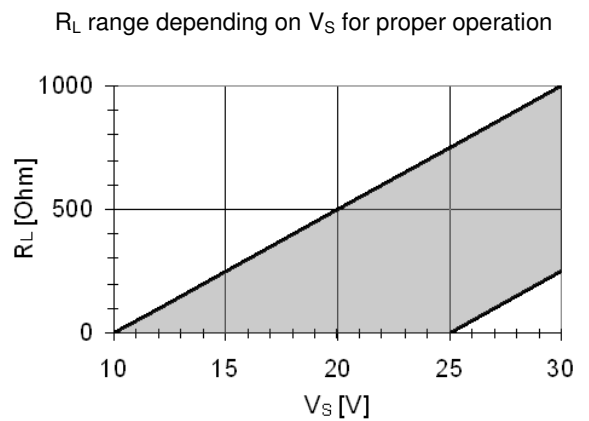
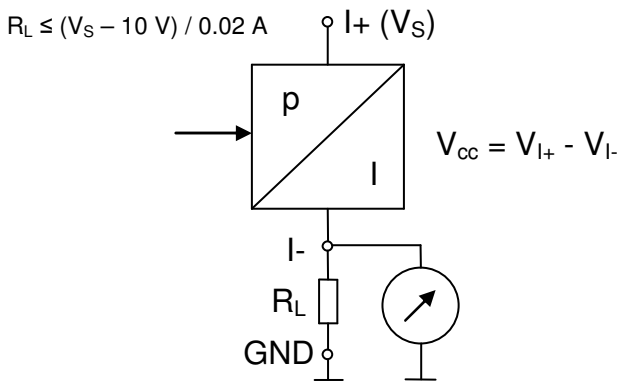
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Output signal @ $T_a = 25\text{ °C}$, $V_s = 15\text{ V}$, $R_L = 100\ \Omega$						
Offset	I_{CC0}	Simple output AUA, AUR ⁹⁾	3.92	4.0	4.08	mA
		Symmetrical output AUS ⁹⁾	11.92	12.0	12.08	mA
Signal span (Full Scale)	I_{FS}	¹⁰⁾	15.92	16.0	16.08	mA
Nonlinearity	L	Simple output ^{10), 11)}		± 0.1	± 0.25	% FS
		Symmetrical output ^{10), 11)}		± 0.25	± 0.5	% FS
Response time	t_{10-90}	¹²⁾		1		ms
Supply voltage rejection	SVR	^{10), 13)}			± 0.01	% FS/V

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Data in temperature range @ $T_a = -25 \dots 85\text{ °C}$, $V_s = 15\text{ V}$, $R_L = 100\ \Omega$						
Temperature hysteresis		¹⁴⁾		± 0.1	± 0.5	% FS
Data in temperature range @ $T_a = 0 \dots 70\text{ °C}$, $V_s = 15\text{ V}$, $R_L = 100\ \Omega$						
Temperature coefficient of offset	TCI_{CC0}	$p_r < 0.25\text{ bar}$ ¹⁵⁾		± 0.015	± 0.05	% FS/K
		$p_r \geq 0.25\text{ bar}$ ¹⁵⁾		± 0.015	± 0.03	% FS/K
Temperature coefficient of span	TCI_{FS}	¹⁶⁾		± 0.015	± 0.03	% FS/K

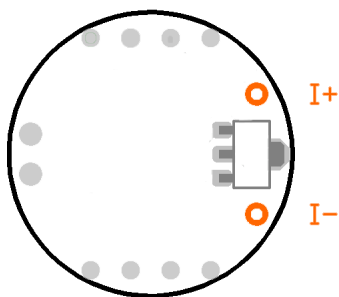
Characteristics



Connection diagram and conditions



Terminal assignment (view to soldering side)



Rated pressures and ordering codes

Pressure measurement	Absolute					Gauge								Gauge, symmetrical			
Rated pressure p_r bar	1.000	2.500	6.000	10.00	25.00	0.100	0.250	0.400	1.000	2.500	6.000	10.00	25.00	0.100	0.250	0.400	1.000
Product type	AUA 1.000 TH C4 TN H P	AUA 2.500 TH C4 TN H P	AUA 6.000 TH C4 TN H P	AUA 10.00 TH C4 TN H P	AUA 25.00 TH C4 TN H P	AUR 0.100 KC C4 TN H P	AUR 0.250 KC C4 TN H P	AUR 0.400 KC C4 TN H P	AUR 1.000 KC C4 TN H P	AUR 2.500 KC C4 TN H P	AUR 6.000 KC C4 TN H P	AUR 10.00 KC C4 TN H P	AUR 25.00 KC C4 TN H P	AUS 0.100 KC C4 TN H P	AUS 0.250 KC C4 TN H P	AUS 0.400 KC C4 TN H P	AUS 1.000 KC C4 TN H P
Ordering code	B58620T0520A001	B58620T0520A002	B58620T0520A003	B58620T0520A004	B58620T0520A005	B58621K0520A001	B58621K0520A002	B58621K0520A003	B58621K0520A004	B58621K0520A005	B58621K0520A006	B58621K0520A007	B58621K0520A008	B58623K0520A001	B58623K0520A002	B58623K0520A003	B58623K0520A004

Other rated pressures upon request.

Symbols and terms

- 1) **Storage temperature range T_{st}**
A storage of the pressure sensor within the temperature range $T_{st,min}$ up to $T_{st,max}$ and without applied pressure and supply voltage will not affect the performance of the pressure sensor.
- 2) **Operating temperature range T_a**
An operation of the pressure sensor within the temperature range $T_{a,min}$ up to $T_{a,max}$ will not affect the performance of the pressure sensor.
- 3) **Compensated temperature range T_c**
While operating the pressure sensor within the temperature range $T_{c,min}$ up to $T_{c,max}$, the deviation of the output signal from the values at 25 °C will not exceed the temperature coefficients. Out of the compensated temperature range, the deviations may increase.
- 4) **Rated pressure p_r**
Within the rated pressure range 0 up to p_r (symmetrical output: $-p_r$ up to $+p_r$) the signal output characteristic corresponds to this specification.
- 5) **Overpressure p_{ov}**
Pressure cycles within the pressure range 0 up to p_{ov} will not affect the performance of the pressure sensor.
- 6) **Supply voltage V_{CC}**
 $V_{CC,max}$ is the maximum permissible supply voltage, which can be applied without damages.
 $V_{CC,min}$ is the minimum required supply voltage, which has to be applied for normal operation.
- 7) **Working resistance R_L**
Depending on V_S , the maximum working resistance is $R_L \leq (V_S - 10 \text{ V}) / 0.02 \text{ A}$.
- 8) **DC break down voltage V_{is}**
The pressure sensor withstands a high voltage between the stainless steel casing and the electrical connection I+ and I- (short circuited) without damage.
- 9) **Offset I_{CC0}**
The offset I_{CC0} is the signal output $I_{CC}(p = 0)$ at zero pressure.
- 10) **Signal span (Full Scale)**
Simple output: $I_{FS} = FS = I_{CC}(p_r) - I_{CC0}$
Symmetrical output: $I_{FS} = FS = I_{CC}(+p_r) - I_{CC}(-p_r)$
- 11) **Nonlinearity L (including pressure hysteresis)**
The nonlinearity is the deviation of the real sensor characteristic $I_{CC} = f(p)$ from the ideal straight line. It can be approximated by a polynomial of second order, with the maximum at $p_x = p_r / 2$.
The equation to calculate the nonlinearity is:
$$L = \frac{I_{CC}(p_x) - I_{CC0} - \frac{p_x}{p_r} (I_{CC}(p_r) - I_{CC0})}{I_{CC}(p_r) - I_{CC0}}$$
- 12) **Response time t_{10-90}**
Delay between a pressure change (10 ... 90% p_r) and the corresponding signal output change (10 ... 90% FS).
- 13) **Supply voltage rejection SVR**
While varying the supply voltage within the range $V_{CC,min}$ up to $V_{CC,max}$ at constant pressure and temperature, the signal output change will not exceed SVR_{max} .
- 14) **Temperature hysteresis**
The temperature hysteresis is the change of offset, starting from the value at 25 °C after a temperature change and return to 25 °C. Determined during temperature cycles in operating temperature range (cycles with 1 K/min).
- 15) **Temperature coefficient of offset TCl_{CC0}**
Offset at temperature T_x : $I_{CC0}(T_x) = I_{CC0}(25 \text{ °C}) + I_{FS}(25 \text{ °C}) \cdot (T_x - 25 \text{ °C}) \cdot TCl_{CC0}$
Values are valid within the compensated temperature range $T_{c,min}$ up to $T_{c,max}$
Out of the compensated temperature range, the deviation may increase.
- 16) **Temperature coefficient of span TCl_{FS}**
Span at temperature T_x : $I_{FS}(T_x) = I_{FS}(25 \text{ °C}) \cdot [1 + (T_x - 25 \text{ °C}) \cdot TCl_{FS}]$
Values are valid within the compensated temperature range $T_{c,min}$ up to $T_{c,max}$
Out of the compensated temperature range, the deviation may increase.

Cautions and warnings

Storage (general)

All pressure sensors should be stored in their original packaging. They should not be placed in harmful environments such as corrosive gases nor exposed to heat or direct sunlight, which may cause deformations. Similar effects may result from extreme storage temperatures and climatic conditions. Avoid storing the sensor dies in an environment where condensation may form or in a location exposed to corrosive gases, which will adversely affect their performance. Plastic materials should not be used for wrapping/packing when storing or transporting these dies, as they may become charged. Pressure sensor dies should be used soon after opening their seal and packaging.

Operation (general)

Media compatibility with the pressure sensors must be ensured to prevent their failure. The use of other media can cause damage and malfunction. Never use pressure sensors in atmospheres containing explosive liquids or gases.

Ensure pressure equalization to the environment, if gauge pressure sensors are used. Avoid operating the pressure sensors in an environment where condensation may form or in a location exposed to corrosive gases. These environments adversely affect their performance.

If the operating pressure is not within the rated pressure range, it may change the output characteristics. This may also happen with pressure sensor dies if an incorrect mounting method is used. Be sure that the applicable pressure does not exceed the overpressure, as it may damage the pressure sensor.

Do not exceed the maximum rated supply voltage nor the rated storage temperature range, as it may damage the pressure sensor.

Temperature variations in both the ambient conditions and the media (liquid or gas) can affect the accuracy of the output signal from the pressure sensors. Be sure to check the operating temperature range and thermal error specification of the pressure sensors to determine their suitability for the application.

Connections must be wired in accordance with the terminal assignment specified in the data sheets. Care should be taken as reversed pin connections can damage the pressure transmitters or degrade their performance. Contact between the pressure sensor terminals and metals or other materials may cause errors in the output characteristics.

Design notes (dies)

This specification describes the mechanical, electrical and physical requirements of a piezoresistive sensor die for measuring pressure. The specified parameters are valid for the pressure sensor die with pressure application either to the front or back side of the diaphragm as described in the data sheet. Pressure application to the other side may result in differing data. Most of the parameters are influenced by assembly conditions. Hence these parameters and the reliability have to be specified for each specific application and tested over its temperature range by the customer.

Handling/Mounting (dies)

Pressure sensor dies should be handled appropriately and not be touched with bare hands. They should only be picked up manually by the sides using tweezers. Their top surface should never be touched with tweezers. Latex gloves should not be used for handling them, as this will inhibit the curing of the adhesive used to bond the die to the carrier. When handling, be careful to avoid cuts caused by the sharp-edged terminals. The sensor die must not be contaminated during manufacturing processes (gluing, soldering, silk-screen process).

The package of pressure sensor dies should not to be opened until the die is mounted and should be closed after use. The sensor die must not be cleaned. The sensor die must not be damaged during the assembly process (especially scratches on the diaphragm).

Soldering (transducers, transmitters)

The thermal capacity of pressure sensors is normally low, so steps should be taken to minimize the effects of external heat. High temperatures may lead to damage or changes in characteristics.

A non-corrosive type of flux resin should normally be used and complete removal of the flux is recommended. Avoid rapid cooling due to dipping in solvent. Note that the output signal may change if pressure is applied to the terminals during soldering.

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

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